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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Active
Core Processor	M16C/60
Core Size	16-Bit
Speed	32MHz
Connectivity	EBI/EMI, I <sup>2</sup> C, SIO, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	85
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	47K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f3650ncnfa-v0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f3650ncnfa-v0</a>

**Table 1.4 Specifications for the 100-Pin Package (2/2)**

Item	Function	Description
Timers	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse width modulation (PWM) mode Event counter two-phase pulse signal processing (two-phase encoder input) × 3 Programmable output mode × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse period measurement mode, pulse width measurement mode
	Three-phase motor control timer functions	• Three-phase inverter control (timer A1, timer A2, timer A4, timer B2) • On-chip dead time timer
	Real-time clock	Count: seconds, minutes, hours, days of the week
	PWM function	8 bits × 2
Serial Interface	Remote control signal receiver	• 2 circuits • 4 wave pattern matchings (differentiate wave pattern for headers, data 0, data 1, and special data) • 6-byte receive buffer (1 circuit only) • Operating frequency of 32 kHz
	UART0 to UART2, UART5 to UART7	Clock synchronous/asynchronous × 6 channels I <sup>2</sup> C-bus, IEbus, special mode 2 SIM (UART2)
SI/O3, SI/O4		Clock synchronization only × 2 channels
Multi-master I <sup>2</sup> C-bus Interface		1 channel
CEC Functions (2)		CEC transmit/receive, arbitration lost detection, ACK automatic output, operation frequency of 32 kHz
A/D Converter		10-bit resolution × 26 channels, including sample and hold function Conversion time: 1.72 μs
D/A Converter		8-bit resolution × 2 circuits
CRC Calculator		CRC-CCITT ( $X^{16} + X^{12} + X^5 + 1$ ), CRC-16 ( $X^{16} + X^{15} + X^2 + 1$ ) compliant
Flash Memory		• Program and erase power supply voltage: 2.7 to 5.5 V • Program and erase cycles: 1,000 times (program ROM 1, program ROM 2), 10,000 times (data flash) • Program security: ROM code protect, ID code check
Debug Functions		On-chip debug, on-board flash rewrite, address match interrupt × 4
Operation Frequency/Supply Voltage		25 MHz/VCC1 = 2.7 to 5.5 V, VCC2 = 2.7 V to VCC1 32 MHz/VCC1 = 2.7 to 5.5 V, VCC2 = 2.7 V to VCC1
Current Consumption		Refer to the Electrical Characteristics chapter
Operating Temperature		-20°C to 85°C, -40°C to 85°C (1)
Package		100-pin QFP: PRQP0100JD-B (Previous package code: 100P6F-A) 100-pin LQFP: PLQP0100KB-A (Previous package code: 100P6Q-A)

Notes:

1. See Table 1.5 "Product List (N-Version)" to Table 1.6 "Product List (D-Version)" for the operating temperature.
2. The CEC function indicates circuitry which supports the transmission and reception of CEC signals standardized by the High-Definition Multimedia Interface (HDMI). HDMI and High-Definition Multimedia Interface are registered trademarks of HDMI Licensing, LLC.

## 1.4 Block Diagram

Figure 1.3 to Figure 1.4 show block diagrams.

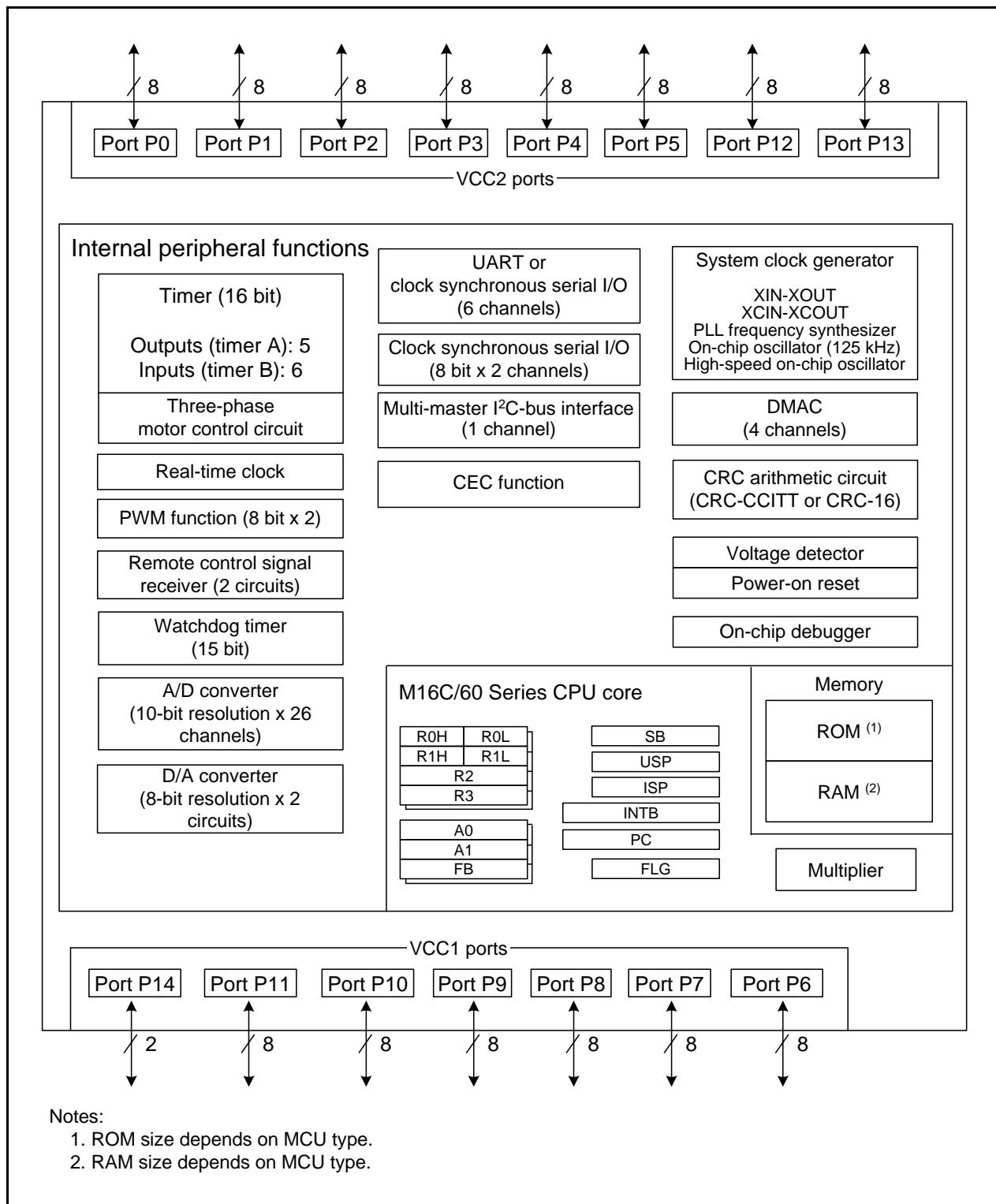


Figure 1.3 Block Diagram for the 128-Pin Package

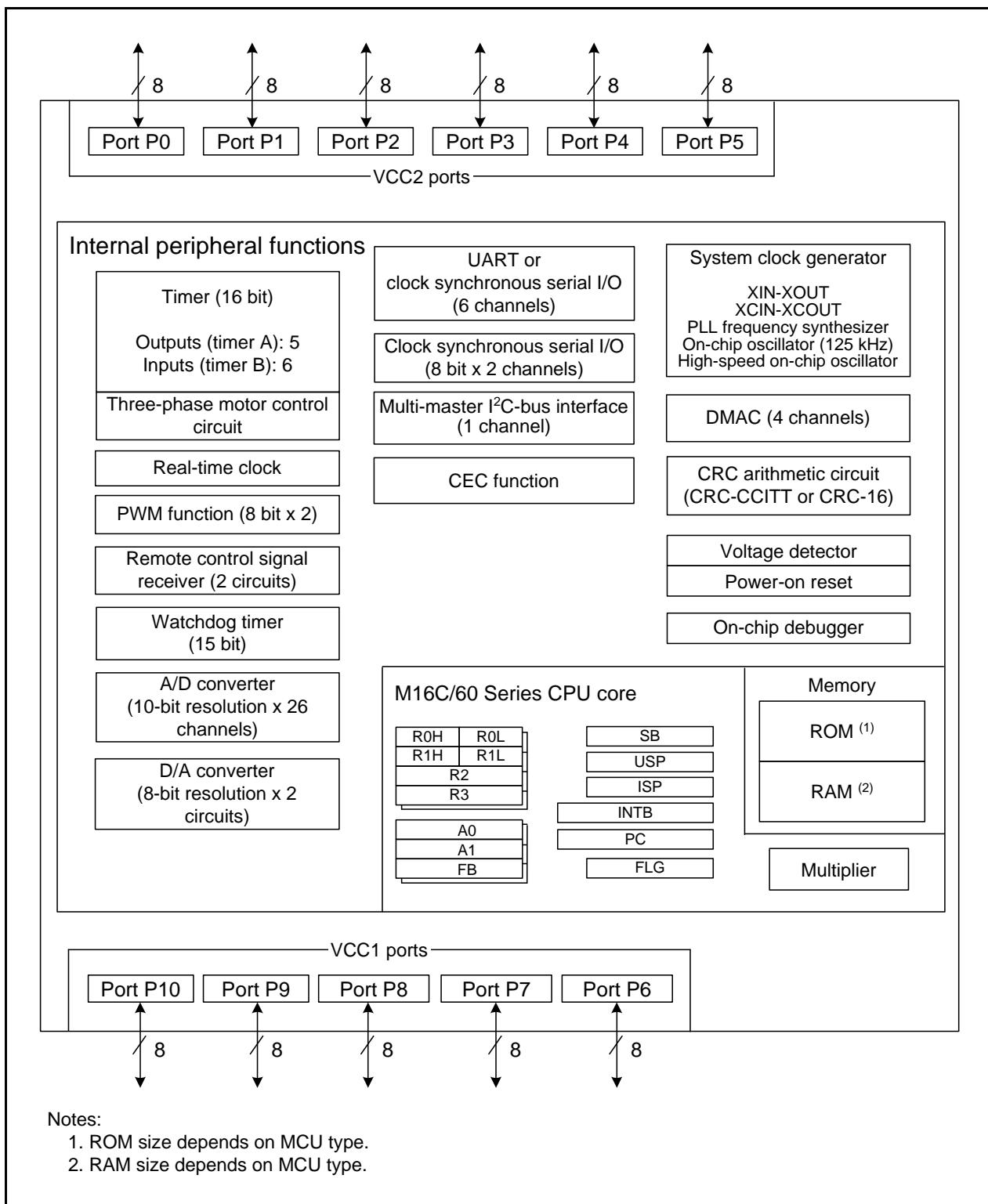


Figure 1.4 Block Diagram for the 100-Pin Package

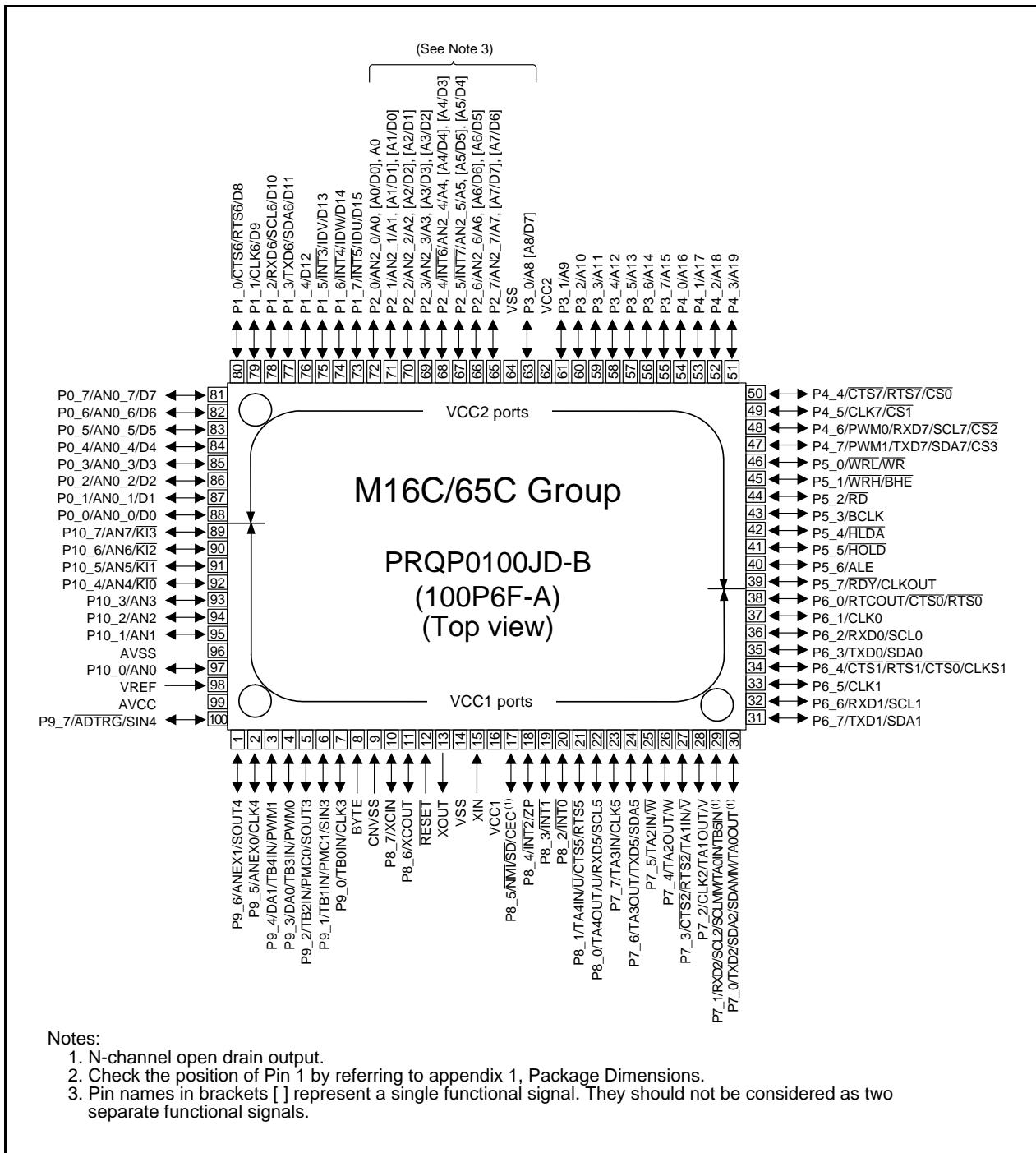


Figure 1.6 Pin Assignment for the 100-Pin Package

**Table 1.16 Pin Functions for the 100-Pin Package (2/3)**

Signal Name	Pin Name	I/O	Power Supply	Description
Main clock input	XIN	I	VCC1	I/O for the main clock oscillator. Connect a ceramic resonator or crystal between pins XIN and XOUT. (1)
Main clock output	XOUT	O	VCC1	Input an external clock to XIN pin and leave XOUT pin open.
Sub clock input	XCIN	I	VCC1	I/O for a sub clock oscillator. Connect a crystal between XCIN pin and XCOUT pin. (1) Input an external clock to XCIN pin and leave XCOUT pin open.
Sub clock output	XCOUT	O	VCC1	
BCLK output	BCLK	O	VCC2	Outputs the BCLK signal.
Clock output	CLKOUT	O	VCC2	Outputs a clock with the same frequency as fC, f1, f8, or f32.
INT interrupt input	INT0 to INT2	I	VCC1	Input for the INT interrupt.
	INT3 to INT7	I	VCC2	
NMI interrupt input	NMI	I	VCC1	Input for the NMI interrupt.
Key input interrupt input	KI0 to KI3	I	VCC1	Input for the key input interrupt.
Timer A	TA0OUT to TA4OUT	I/O	VCC1	I/O for timers A0 to A4 (TA0OUT is N-channel open drain output).
	TA0IN to TA4IN	I	VCC1	Input for timers A0 to A4.
	ZP	I	VCC1	Input for Z-phase.
Timer B	TB0IN to TB5IN	I	VCC1	Input for timers B0 to B5.
Three-phase motor control timer	U, $\bar{U}$ , V, $\bar{V}$ , W, $\bar{W}$	O	VCC1	Output for the three-phase motor control timer.
	SD	I	VCC1	Forced cutoff input.
	IDU, IDV, IDW	I	VCC2	Input for the position data.
Real-time clock output	RTCOUT	O	VCC1	Output for the real-time clock.
PWM output	PWM0, PWM1	O	VCC1, VCC2	PWM output.
Remote control signal receiver input	PMC0, PMC1	I	VCC1	Input for the remote control signal receiver.
Serial interface UART0 to UART2, UART5 to UART7	CTS0 to CTS2, CTS5	I	VCC1	Input pins to control data transmission.
	CTS6, CTS7	I	VCC2	
	RTS0 to RTS2, RTS5	O	VCC1	Output pins to control data reception.
	RTS6, RTS7	O	VCC2	
	CLK0 to CLK2, CLK5	I/O	VCC1	Transmit/receive clock I/O.
	CLK6, CLK7	I/O	VCC2	
	RXD0 to RXD2, RXD5	I	VCC1	Serial data input.
	RXD6, RXD7	I	VCC2	
	TXD0 to TXD2, TXD5	O	VCC1	Serial data output. (2)
	TXD6, TXD7	O	VCC2	
	CLKS1	O	VCC1	Output for the transmit/receive clock multiple-pin output function.

Notes:

1. Contact the manufacturer of crystal/ceramic resonator regarding the oscillation characteristics.
2. TXD2, SDA2, and SCL2 are N-channel open drain output pins. TXDi (i = 0, 1, 5 to 7), SDAi, and SCLi can be selected as CMOS output pins or N-channel open drain output pins.

## 2.1 Data Registers (R0, R1, R2, and R3)

R0, R1, R2, and R3 are 16-bit registers used for transfer, arithmetic, and logic operations. R0 and R1 can be split into upper (R0H/R1H) and lower (R0L/R1L) bits to be used separately as 8-bit data registers. R0 can be combined with R2, and R3 can be combined with R1 and be used as 32-bit data registers R2R0 and R3R1, respectively.

## 2.2 Address Registers (A0 and A1)

A0 and A1 are 16-bit registers used for indirect addressing, relative addressing, transfer, arithmetic, and logic operations. A0 can be combined with A1 and used as a 32-bit address register (A1A0).

## 2.3 Frame Base Register (FB)

FB is a 16-bit register that is used for FB relative addressing.

## 2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the start address of a relocatable interrupt vector table.

## 2.5 Program Counter (PC)

The PC is 20 bits wide and indicates the address of the next instruction to be executed.

## 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The USP and ISP stack pointers (SP) are each comprised of 16 bits. The U flag is used to switch between USP and ISP.

## 2.7 Static Base Register (SB)

SB is a 16-bit register used for SB relative addressing.

## 2.8 Flag Register (FLG)

FLG is an 11-bit register that indicates the CPU state.

### 2.8.1 Carry Flag (C Flag)

The C flag retains a carry, borrow, or shift-out bit generated by the arithmetic/logic unit.

### 2.8.2 Debug Flag (D Flag)

The D flag is for debugging only. Set it to 0.

### 2.8.3 Zero Flag (Z Flag)

The Z flag becomes 1 when an arithmetic operation results in 0. Otherwise, it becomes 0.

### 2.8.4 Sign Flag (S Flag)

The S flag becomes 1 when an arithmetic operation results in a negative value. Otherwise, it becomes 0.

### 2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is 1.

### 2.8.6 Overflow Flag (O Flag)

The O flag becomes 1 when an arithmetic operation results in an overflow. Otherwise, it becomes 0.

## 3. Address Space

### 3.1 Address Space

The M16C/65C Group has a 1 MB address space from 00000h to FFFFFh. Address space is expandable to 4 MB with the memory area expansion function. Addresses 40000h to BFFFFh can be used as external areas from bank 0 to bank 7. Figure 3.1 shows the Address Space. Areas that can be accessed vary depending on processor mode and the status of each control bit.

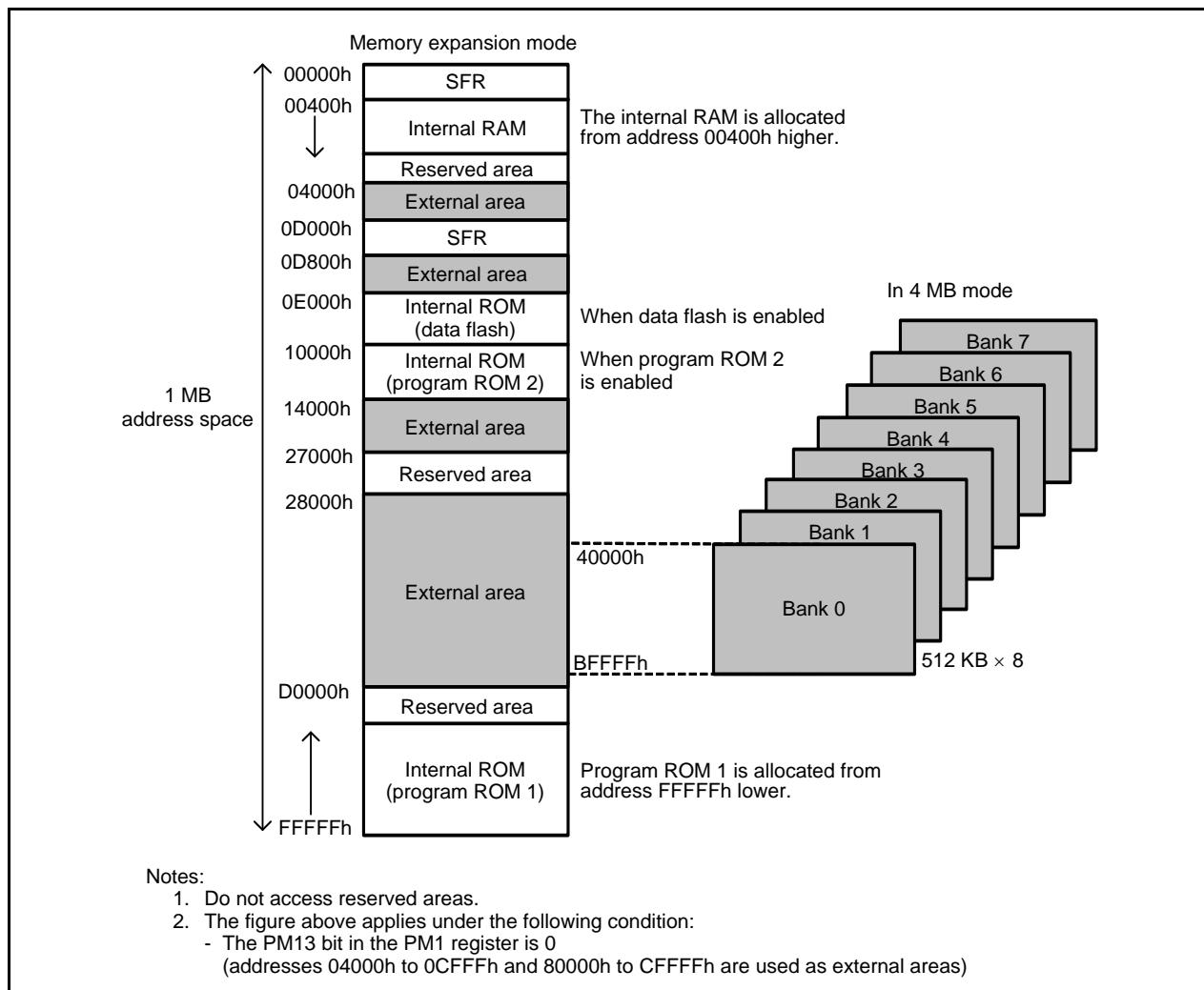


Figure 3.1 Address Space

## 4.2 Notes on SFRs

### 4.2.1 Register Settings

Table 4.19 lists Registers with Write-Only Bits and registers whose function differs between reading and writing. Set these registers with immediate values. Do not use read-modify-write instructions. When establishing the next value by altering the existing value, write the existing value to the RAM as well as to the register. Transfer the next value to the register after making changes in the RAM.

Read-modify-write instructions can be used when writing to the no register bits.

**Table 4.19 Registers with Write-Only Bits**

Address	Register	Symbol
0249h	UART0 Bit Rate Register	U0BRG
024Bh to 024Ah	UART0 Transmit Buffer Register	U0TB
0259h	UART1 Bit Rate Register	U1BRG
025Bh to 025Ah	UART1 Transmit Buffer Register	U1TB
0269h	UART2 Bit Rate Register	U2BRG
026Bh to 026Ah	UART2 Transmit Buffer Register	U2TB
0273h	SI/O3 Bit Rate Register	S3BRG
0277h	SI/O4 Bit Rate Register	S4BRG
0289h	UART5 Bit Rate Register	U5BRG
028Bh to 028Ah	UART5 Transmit Buffer Register	U5TB
0299h	UART6 Bit Rate Register	U6BRG
029Bh to 029Ah	UART6 Transmit Buffer Register	U6TB
02A9h	UART7 Bit Rate Register	U7BRG
02ABh to 02AAh	UART7 Transmit Buffer Register	U7TB
02B6h	I2C0 Control Register 1	S3D0
02B8h	I2C0 Status Register 0	S10
0303h to 0302h	Timer A1-1 Register	TA11
0305h to 0304h	Timer A2-1 Register	TA21
0307h to 0306h	Timer A4-1 Register	TA41
030Ah	Three-Phase Output Buffer Register 0	IDB0
030Bh	Three-Phase Output Buffer Register 1	IDB1
030Ch	Dead Time Timer	DTT
030Dh	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2
0327h to 0326h	Timer A0 Register	TA0
0329h to 0328h	Timer A1 Register	TA1
032Bh to 032Ah	Timer A2 Register	TA2
032Dh to 032Ch	Timer A3 Register	TA3
032Fh to 032Eh	Timer A4 Register	TA4
037Dh	Watchdog Timer Refresh Register	WDTR
037Eh	Watchdog Timer Start Register	WDTS

**Table 4.20 Read-Modify-Write Instructions**

Function	Mnemonic
Transfer	MOVDir
Bit processing	BCLR, BMCnd, BNOT, BSET, BTSTC, and BTSTS
Shifting	ROLC, RORC, ROT, SHA, and SHL
Arithmetic operation	ABS, ADC, ADCF, ADD, DEC, DIV, DIVU, DIVX, EXTS, INC, MUL, MULU, NEG, SBB, and SUB
Decimal operation	DADC, DADD, DSBB, and DSUB
Logical operation	AND, NOT, OR, and XOR
Jump	ADJNZ, SBJNZ

## 5. Electrical Characteristics

### 5.1 Electrical Characteristics (Common to 3 V and 5 V)

#### 5.1.1 Absolute Maximum Rating

**Table 5.1 Absolute Maximum Ratings**

Symbol	Parameter		Condition	Rated Value	Unit
$V_{CC1}$	Supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to 6.5	V
$V_{CC2}$	Supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to $V_{CC1} + 0.1$ (1)	V
$AV_{CC}$	Analog supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to 6.5	V
$V_{REF}$	Analog reference voltage		$V_{CC1} = AV_{CC}$	-0.3 to $V_{CC1} + 0.1$ (1)	V
$V_I$	Input voltage	RESET, CNVSS, BYTE, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XIN		-0.3 to $V_{CC1} + 0.3$ (1)	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		-0.3 to $V_{CC2} + 0.3$ (1)	V
		P7_0, P7_1, P8_5		-0.3 to 6.5	V
$V_O$	Output voltage	P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XOUT		-0.3 to $V_{CC1} + 0.3$ (1)	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		-0.3 to $V_{CC2} + 0.3$ (1)	V
		P7_0, P7_1, P8_5		-0.3 to 6.5	V
$P_d$	Power consumption		$-40^{\circ}\text{C} < T_{opr} \leq 85^{\circ}\text{C}$	300	mW
$T_{opr}$	Operating temperature	When the MCU is operating		-20 to 85/-40 to 85	$^{\circ}\text{C}$
		Flash program erase	Program area Data area	0 to 60 -20 to 85/-40 to 85	
$T_{stg}$	Storage temperature			-65 to 150	$^{\circ}\text{C}$

Note:

1. Maximum value is 6.5 V.

$$V_{CC1} = V_{CC2} = 5 \text{ V}$$

**Timing Requirements**

( $V_{CC1} = V_{CC2} = 5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ /-40°C to  $85^\circ\text{C}$  unless otherwise specified)

**5.2.2.4 Timer B Input****Table 5.29 Timer B Input (Counter Input in Event Counter Mode)**

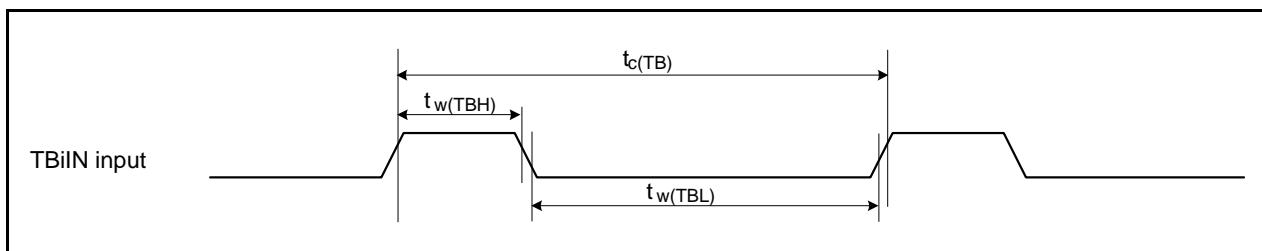
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time (counted on one edge)	100		ns
$t_w(TBH)$	TBiN input high pulse width (counted on one edge)	40		ns
$t_w(TBL)$	TBiN input low pulse width (counted on one edge)	40		ns
$t_c(TB)$	TBiN input cycle time (counted on both edges)	200		ns
$t_w(TBH)$	TBiN input high pulse width (counted on both edges)	80		ns
$t_w(TBL)$	TBiN input low pulse width (counted on both edges)	80		ns

**Table 5.30 Timer B Input (Pulse Period Measurement Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time	400		ns
$t_w(TBH)$	TBiN input high pulse width	200		ns
$t_w(TBL)$	TBiN input low pulse width	200		ns

**Table 5.31 Timer B Input (Pulse Width Measurement Mode)**

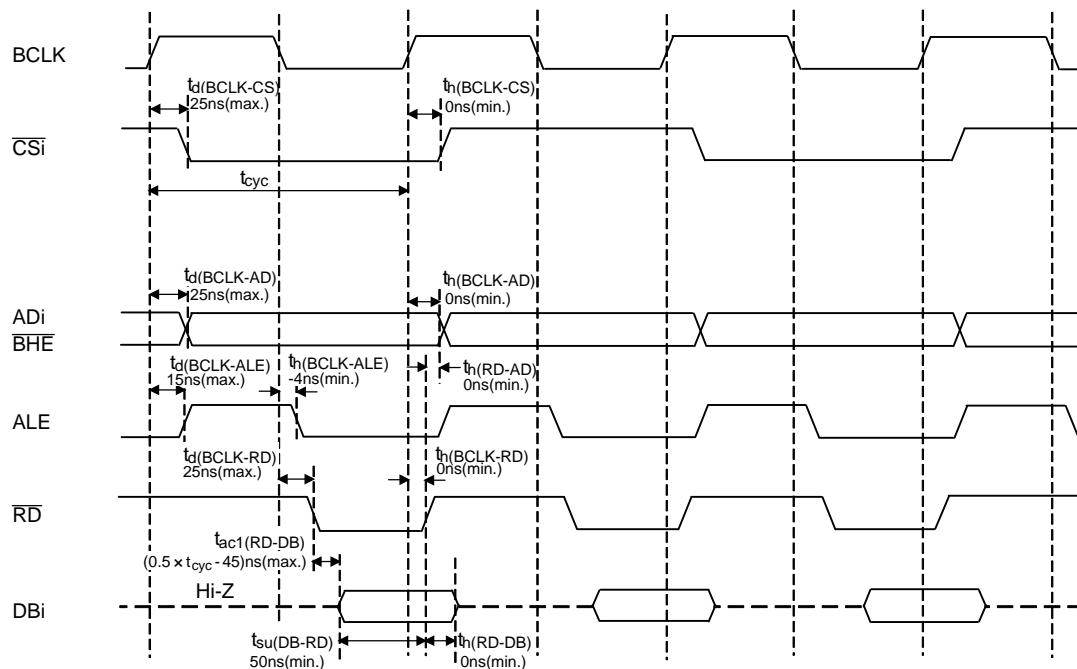
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time	400		ns
$t_w(TBH)$	TBiN input high pulse width	200		ns
$t_w(TBL)$	TBiN input low pulse width	200		ns

**Figure 5.9 Timer B Input**

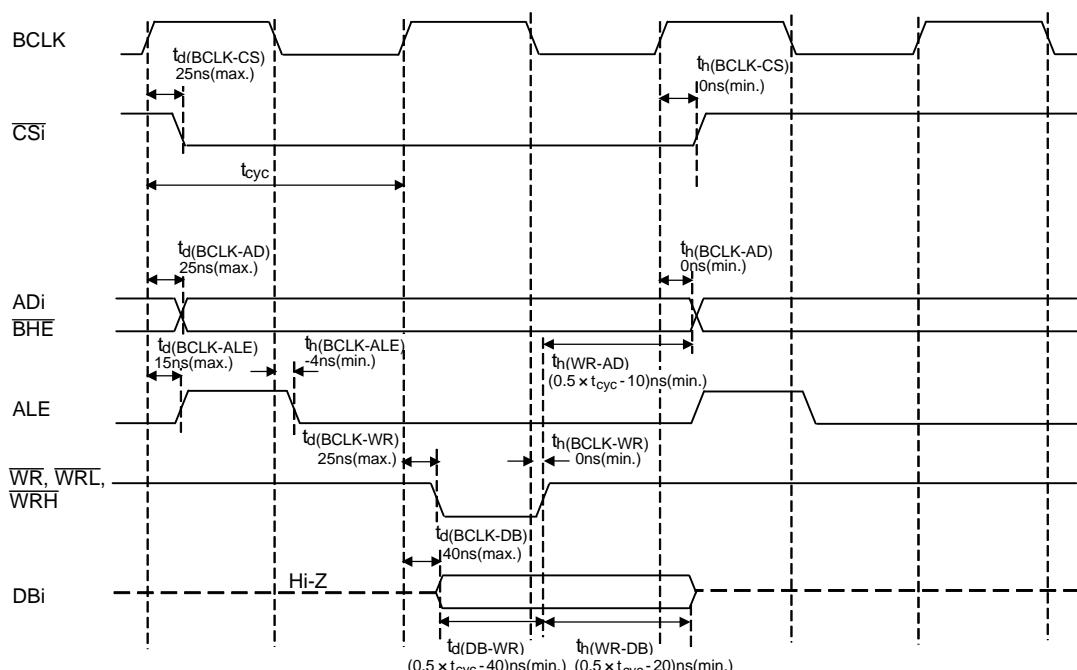
Memory Expansion Mode and Microprocessor Mode  
(in no wait state setting)

$$V_{CC1} = V_{CC2} = 5V$$

#### Read timing



#### Write timing



$$t_{cyc} = \frac{1}{f(BCLK)}$$

#### Measuring conditions

- $V_{CC1} = V_{CC2} = 5V$
- Input timing voltage:  $V_L = 0.8 V$ ,  $V_H = 2.0 V$
- Output timing voltage:  $V_L = 0.4 V$ ,  $V_H = 2.4 V$

Figure 5.15 Timing Diagram

$$V_{CC1} = V_{CC2} = 5 \text{ V}$$

### Switching Characteristics

( $V_{CC1} = V_{CC2} = 5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ /-40°C to 85°C unless otherwise specified)

#### 5.2.4.2 In 1 to 3 Waits Setting and When Accessing External Area

**Table 5.37 Memory Expansion Mode and Microprocessor Mode (in 1 to 3 Waits Setting and When Accessing External Area)**

Symbol	Parameter	Measuring Condition	Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address output delay time	See Figure 5.14		25	ns
$t_h(BCLK-AD)$	Address output hold time (in relation to BCLK)		0		ns
$t_h(RD-AD)$	Address output hold time (in relation to RD)		0		ns
$t_h(WR-AD)$	Address output hold time (in relation to WR)		(Note 2)		ns
$t_d(BCLK-CS)$	Chip select output delay time			25	ns
$t_h(BCLK-CS)$	Chip select output hold time (in relation to BCLK)		0		ns
$t_d(BCLK-ALE)$	ALE signal output delay time			15	ns
$t_h(BCLK-ALE)$	ALE signal output hold time		-4		ns
$t_d(BCLK-RD)$	RD signal output delay time			25	ns
$t_h(BCLK-RD)$	RD signal output hold time		0		ns
$t_d(BCLK-WR)$	WR signal output delay time			25	ns
$t_h(BCLK-WR)$	WR signal output hold time		0		ns
$t_d(BCLK-DB)$	Data output delay time (in relation to BCLK)			40	ns
$t_d(DB-WR)$	Data output delay time (in relation to WR)		(Note 1)		ns
$t_h(WR-DB)$	Data output hold time (in relation to WR) <sup>(3)</sup>		(Note 4)		ns

Notes:

- Calculated according to the BCLK frequency as follows:

$$\frac{(n - 0.5) \times 10^9}{f_{(BCLK)}} - 40[\text{ns}] \quad n \text{ is 1 for 1 wait setting, 2 for 2 waits setting and 3 for 3 waits setting.}$$

When  $n = 1$ ,  $f_{(BCLK)}$  is 12.5 MHz or less.

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 10[\text{ns}]$$

- This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

Hold time of data bus is expressed in

$$t = -CR \times \ln(1 - V_{OL}/V_{CC2})$$

by a circuit of the right figure.

For example, when  $V_{OL} = 0.2V_{CC2}$ ,  $C = 30 \text{ pF}$ ,  $R = 1 \text{ k}\Omega$ , hold time of output low level is

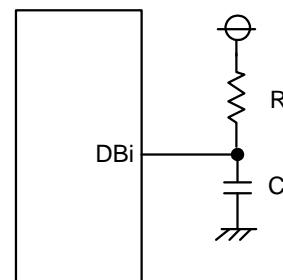
$$t = -30 \text{ pF} \times 1 \text{ k}\Omega \times \ln(1 - 0.2V_{CC2}/V_{CC2})$$

$$= 6.7 \text{ ns.}$$

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 20[\text{ns}]$$

Hold time is equal to or less than 0 ns when the BCLK frequency exceeds 25 MHz.



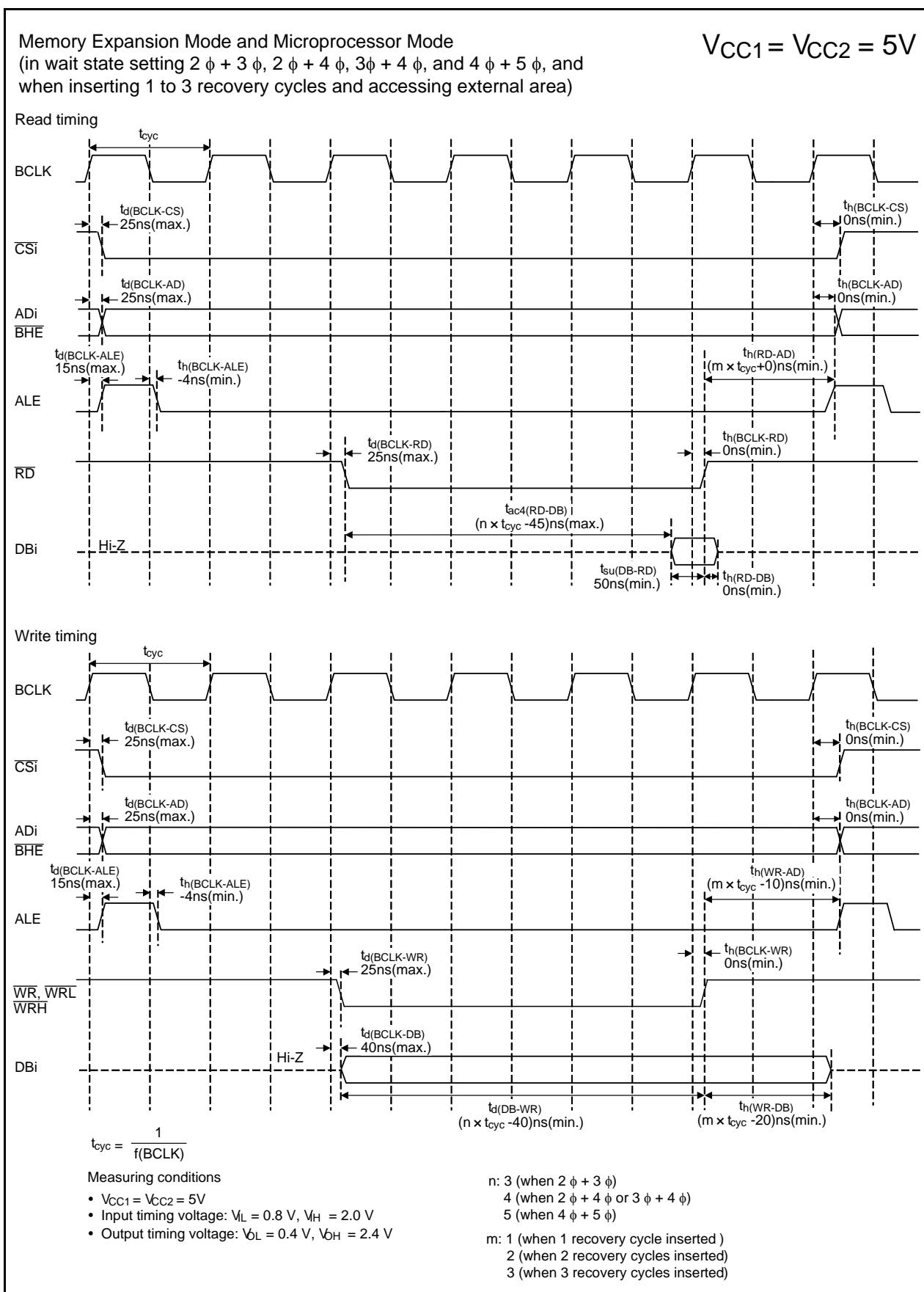


Figure 5.19 Timing Diagram

### 5.3 Electrical Characteristics ( $V_{CC1} = V_{CC2} = 3\text{ V}$ )

#### 5.3.1 Electrical Characteristics

$V_{CC1} = V_{CC2} = 3\text{ V}$

**Table 5.41 Electrical Characteristics (1) (1)**

$V_{CC1} = V_{CC2} = 2.7\text{ to }3.3\text{ V}$ ,  $V_{SS} = 0\text{ V}$  at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ /-40°C to 85°C,  $f_{(BCLK)} = 32\text{ MHz}$  unless otherwise specified.

Symbol	Parameter	Measuring Condition	Standard			Unit
			Min.	Typ.	Max.	
$V_{OH}$	High output voltage P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1	$I_{OH} = -1\text{ mA}$	$V_{CC1} - 0.5$		$V_{CC1}$	V
$V_{OH}$	High output voltage XOUT	HIGH POWER	$I_{OH} = -0.1\text{ mA}$	$V_{CC1} - 0.5$	$V_{CC1}$	V
		LOW POWER	$I_{OH} = -50\text{ }\mu\text{A}$	$V_{CC1} - 0.5$	$V_{CC1}$	
	High output voltage XCOUT	HIGH POWER	With no load applied		2.6	V
		LOW POWER	With no load applied		2.2	
$V_{OL}$	Low output voltage P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1	$I_{OL} = 1\text{ mA}$			0.5	V
		$I_{OL} = 1\text{ mA}$			0.5	
		$I_{OL} = 1\text{ mA}$			0.5	
$V_{OL}$	Low output voltage XOUT	HIGH POWER	$I_{OL} = 0.1\text{ mA}$		0.5	V
		LOW POWER	$I_{OL} = 50\text{ }\mu\text{A}$		0.5	
	Low output voltage XCOUT	HIGH POWER	With no load applied		0	V
		LOW POWER	With no load applied		0	
$V_{T+}-V_{T-}$	Hysteresis HOLD, RDY, TA0IN to TA4IN, TB0IN to TB5IN, INT0 to INT7, NM $\bar{I}$ , ADTRG, CTS0 to CTS2, CTS5 to CTS7, SCL0 to SCL2, SCL5 to SCL7, SDA0 to SDA2, SDA5 to SDA7, CLK0 to CLK7, TA0OUT to TA4OUT, KI0 to KI3, RXD0 to RXD2, RXD5 to RXD7, SIN3, SIN4, SD, PMC0, PMC1, SCLMM, SDAMM, ZP, IDU, IDV, IDW			0.2	1.0	V
		CEC		0.2	0.5	
		RESET		0.2	1.8	
$I_{IH}$	High input current P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1 XIN, RESET, CNVSS, BYTE	$V_I = 3\text{ V}$			4.0	$\mu\text{A}$
-	Leakage current in powered-off state	CEC	$V_{CC1} = 0\text{ V}$		1.8	$\mu\text{A}$
$I_{IL}$	Low input current P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1 XIN, RESET, CNVSS, BYTE	$V_I = 0\text{ V}$			-4.0	$\mu\text{A}$
$R_{PULLUP}$	Pull-up resistance P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1	$V_I = 0\text{ V}$	50	80	150	$\text{k}\Omega$
$R_{fXIN}$	Feedback resistance XIN			3.0		$\text{M}\Omega$
$V_{RAM}$	RAM retention voltage	In stop mode	1.8			V

Note:

- When  $V_{CC1} \neq V_{CC2}$ , refer to 5 V or 3 V standard depending on the voltage.

$$V_{CC1} = V_{CC2} = 3 \text{ V}$$

**Table 5.43 Electrical Characteristics (3) (1/2)**

R5F3651ECNFC, R5F3651KCNFC, R5F3650KCNFA, R5F3650KCNFB, R5F3651MCNFC, R5F3650MCNFA,  
 R5F3650MCNFB, R5F3651NCNFC, R5F3650NCNFA, R5F3650NCNFB,  
 R5F3651ECDFC, R5F3651KCDFC, R5F3650KCDFA, R5F3650KCDFB, R5F3651MCDFC, R5F3650MCDFA,  
 R5F3650MCDFB, R5F3651NCDFC, R5F3650NCDFA, R5F3650NCDFB  
 $V_{CC1} = V_{CC2} = 2.7 \text{ to } 3.3 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$  at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ / $-40^\circ\text{C}$  to  $85^\circ\text{C}$ ,  $f_{(BCLK)} = 32 \text{ MHz}$  unless otherwise specified.

Symbol	Parameter	Measuring Condition	Standard			Unit
			Min.	Typ.	Max.	
$R_{fxCIN}$	Feedback resistance XCIN			16		$\text{m}\Omega$
$I_{CC}$	Power supply current	High-speed mode	$f_{(BCLK)} = 32 \text{ MHz}$ $XIN = 4 \text{ MHz}$ (square wave), PLL multiplied by 8 125 kHz on-chip oscillator stopped		26.0	$\text{mA}$
			$f_{(BCLK)} = 32 \text{ MHz}$ , A/D conversion $XIN = 4 \text{ MHz}$ (square wave), PLL multiplied by 8 125 kHz on-chip oscillator stopped		27.0	$\text{mA}$
			$f_{(BCLK)} = 20 \text{ MHz}$ $XIN = 20 \text{ MHz}$ (square wave) 125 kHz on-chip oscillator stopped		17.0	$\text{mA}$
		40 MHz on-chip oscillator mode	Main clock stopped 40 MHz on-chip oscillator on, divide-by-4 ( $f_{(BCLK)} = 10 \text{ MHz}$ ) 125 kHz on-chip oscillator stopped		18.0	$\text{mA}$
		125 kHz on-chip oscillator mode	Main clock stopped 40 MHz on-chip oscillator stopped 125 kHz on-chip oscillator on, no division FMR22 = 1 (slow read mode)		500.0	$\mu\text{A}$
		Low-power mode	$f_{(BCLK)} = 32 \text{ MHz}$ In low-power mode, FMR22 = FMR23 = 1 on flash memory (1)		170.0	$\mu\text{A}$
			$f_{(BCLK)} = 32 \text{ MHz}$ In low-power mode, on RAM (1)		40.0	$\mu\text{A}$
		Wait mode	Main clock stopped 40 MHz on-chip oscillator stopped 125 kHz on-chip oscillator on Peripheral clock operating $T_{opr} = 25^\circ\text{C}$		20.0	$\mu\text{A}$
			$f_{(BCLK)} = 32 \text{ MHz}$ (oscillation capacity High) 40 MHz on-chip oscillator stopped 125 kHz on-chip oscillator stopped Peripheral clock operating $T_{opr} = 25^\circ\text{C}$		8.0	$\mu\text{A}$
			$f_{(BCLK)} = 32 \text{ kHz}$ (oscillation capacity Low) 40 MHz on-chip oscillator stopped 125 kHz on-chip oscillator stopped Peripheral clock operating $T_{opr} = 25^\circ\text{C}$		4.0	$\mu\text{A}$
			$XIN = 6 \text{ MHz}$ 40 MHz on-chip oscillator stopped 125 kHz on-chip oscillator stopped Peripheral clock f1 provision disabled except timers (PCKSTP1A = 1) Main clock as a timer clock source (PCKSTP11 = 0, PCKSTP17 = 1) A given timer operating		0.5	$\text{mA}$

Note:

1. This indicates the memory in which the program to be executed exists.

$$V_{CC1} = V_{CC2} = 3 \text{ V}$$

**Timing Requirements**

( $V_{CC1} = V_{CC2} = 3 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ /-40°C to 85°C unless otherwise specified)

**5.3.2.4 Timer B Input****Table 5.52 Timer B Input (Counter Input in Event Counter Mode)**

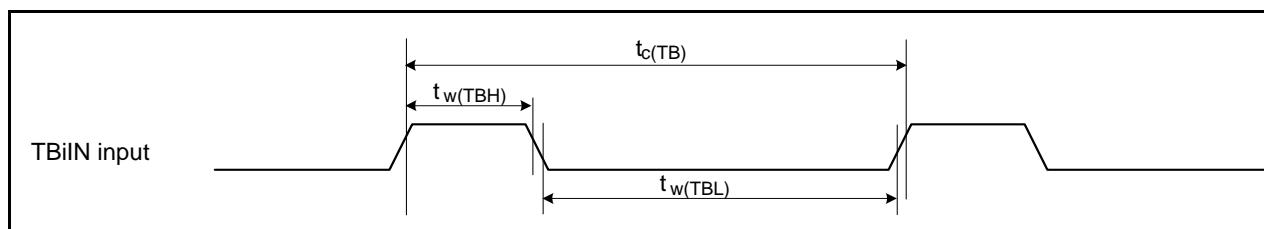
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time (counted on one edge)	150		ns
$t_w(TBH)$	TBiN input high pulse width (counted on one edge)	60		ns
$t_w(TBL)$	TBiN input low pulse width (counted on one edge)	60		ns
$t_c(TB)$	TBiN input cycle time (counted on both edges)	300		ns
$t_w(TBH)$	TBiN input high pulse width (counted on both edges)	120		ns
$t_w(TBL)$	TBiN input low pulse width (counted on both edges)	120		ns

**Table 5.53 Timer B Input (Pulse Period Measurement Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time	600		ns
$t_w(TBH)$	TBiN input high pulse width	300		ns
$t_w(TBL)$	TBiN input low pulse width	300		ns

**Table 5.54 Timer B Input (Pulse Width Measurement Mode)**

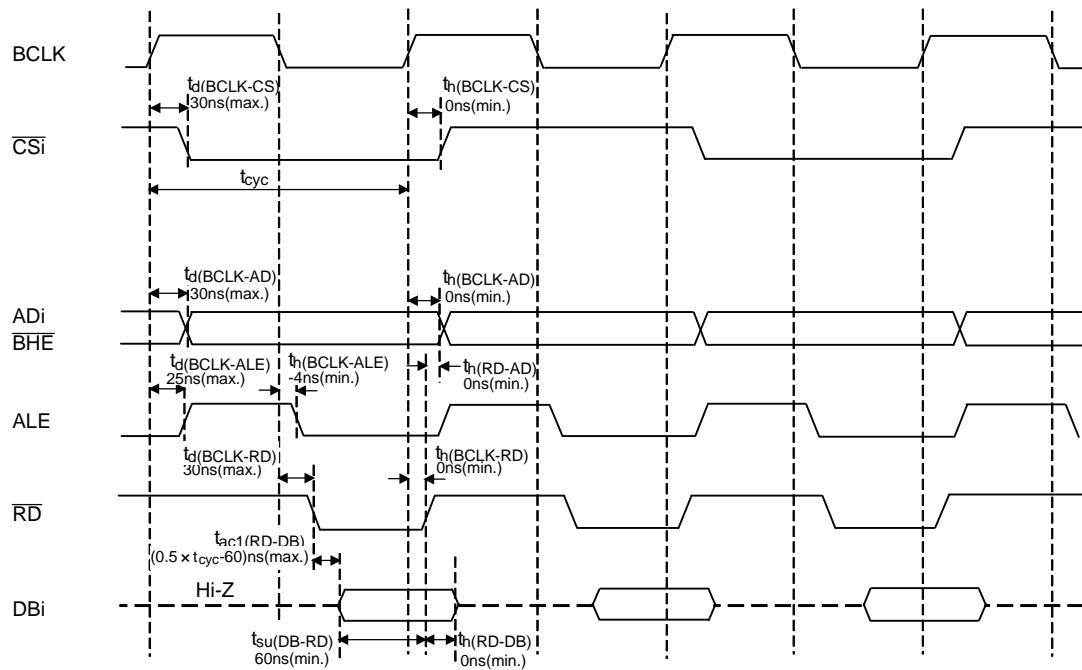
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_c(TB)$	TBiN input cycle time	600		ns
$t_w(TBH)$	TBiN input high pulse width	300		ns
$t_w(TBL)$	TBiN input low pulse width	300		ns

**Figure 5.24 Timer B Input**

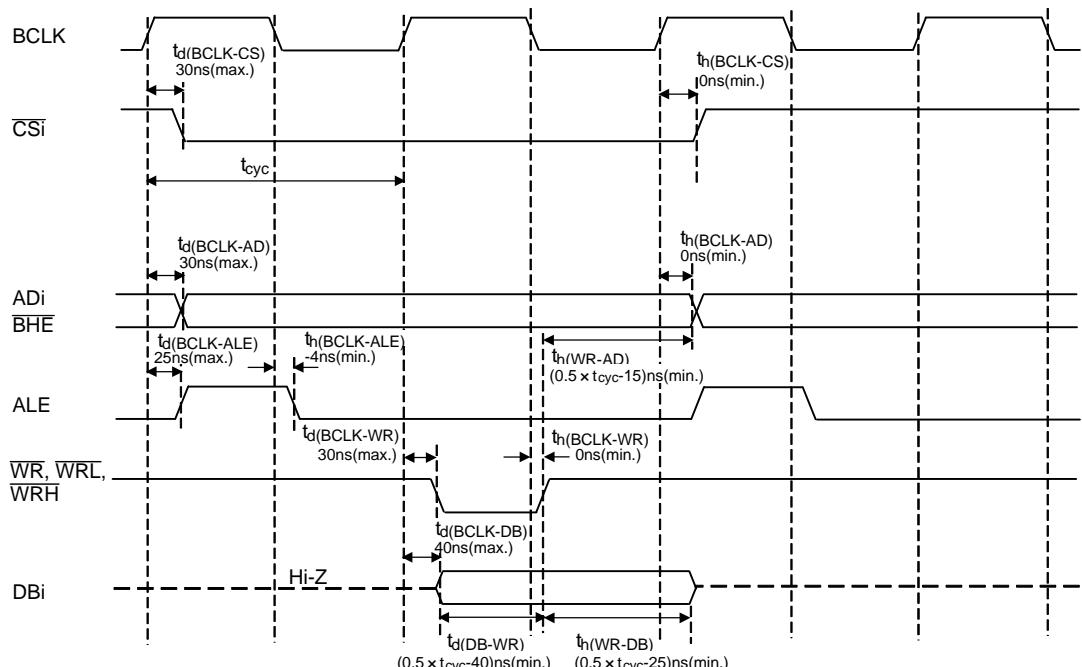
Memory Expansion Mode and Microprocessor Mode  
(in no wait state setting)

$$V_{CC1} = V_{CC2} = 3V$$

#### Read timing



#### Write timing



$$t_{cyc} = \frac{1}{f(BCLK)}$$

#### Measuring conditions

- $V_{CC1} = V_{CC2} = 3V$
- Input timing voltage:  $V_L = 0.6 V$ ,  $V_H = 2.4 V$
- Output timing voltage:  $V_{OL} = 1.5 V$ ,  $V_{OH} = 1.5 V$

Figure 5.30 Timing Diagram

$$V_{CC1} = V_{CC2} = 3 \text{ V}$$

### Switching Characteristics

( $V_{CC1} = V_{CC2} = 3 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , at  $T_{opr} = -20^\circ\text{C}$  to  $85^\circ\text{C}$ /-40°C to 85°C unless otherwise specified)

#### 5.3.4.2 In 1 to 3 Waits Setting and When Accessing External Area

**Table 5.60 Memory Expansion Mode and Microprocessor Mode (in 1 to 3 Waits Setting and When Accessing External Area)**

Symbol	Parameter	Measuring Condition	Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address output delay time	See Figure 5.29		30	ns
$t_h(BCLK-AD)$	Address output hold time (in relation to BCLK)		0		ns
$t_h(RD-AD)$	Address output hold time (in relation to RD)		0		ns
$t_h(WR-AD)$	Address output hold time (in relation to WR)		(Note 2)		ns
$t_d(BCLK-CS)$	Chip select output delay time			30	ns
$t_h(BCLK-CS)$	Chip select output hold time (in relation to BCLK)		0		ns
$t_d(BCLK-ALE)$	ALE signal output delay time			25	ns
$t_h(BCLK-ALE)$	ALE signal output hold time		-4		ns
$t_d(BCLK-RD)$	RD signal output delay time			30	ns
$t_h(BCLK-RD)$	RD signal output hold time		0		ns
$t_d(BCLK-WR)$	WR signal output delay time			30	ns
$t_h(BCLK-WR)$	WR signal output hold time		0		ns
$t_d(BCLK-DB)$	Data output delay time (in relation to BCLK)			40	ns
$t_d(DB-WR)$	Data output delay time (in relation to WR)		(Note 1)		ns
$t_h(WR-DB)$	Data output hold time (in relation to WR) (3)		(Note 4)		ns

Notes:

- Calculated according to the BCLK frequency as follows:

$$\frac{(n-0.5) \times 10^9}{f_{(BCLK)}} - 40[\text{ns}] \quad n \text{ is 1 for 1 wait setting, 2 for 2 waits setting and 3 for 3 waits setting.}$$

When  $n = 1$ ,  $f_{(BCLK)}$  is 12.5 MHz or less.

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 15[\text{ns}]$$

- This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

Hold time of data bus is expressed in

$$t = -CR \times \ln(1 - V_{OL}/V_{CC2})$$

by a circuit of the right figure.

For example, when  $V_{OL} = 0.2V_{CC2}$ ,  $C = 30 \text{ pF}$ ,  $R = 1 \text{ k}\Omega$ , hold time of output low level is

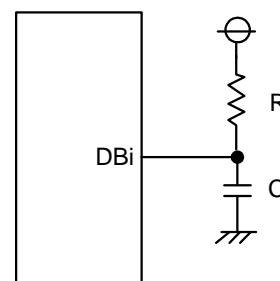
$$t = -30 \text{ pF} \times 1 \text{ k}\Omega \times \ln(1 - 0.2V_{CC2}/V_{CC2})$$

$$= 6.7 \text{ ns.}$$

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 25[\text{ns}]$$

Hold time is equal to or less than 0 ns when the BCLK frequency exceeds 20 MHz.



## Appendix 1. Package Dimensions

The information on the latest package dimensions or packaging may be obtained from "Packages" on the Renesas Electronics website.

